

Features

- 40V/298A,
 $R_{DS(ON)} = 0.9m\Omega(Typ.)@V_{GS}=10V$
 $R_{DS(ON)} = 1.1m\Omega(Typ.)@V_{GS}=4.5V$
- Excellent $Q_G \times R_{DS(on)}$ product(FOM)
- SGT Technology
- 100% Avalanche Tested
- Good Thermal Performance

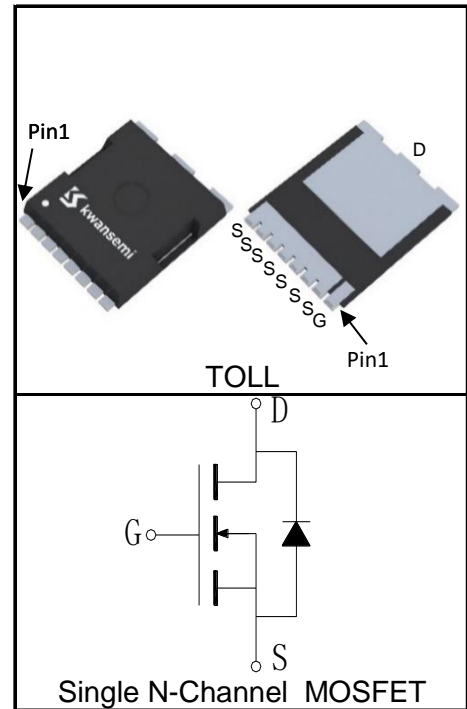
Applications

- Motor Control
- Battery Power Management
- High Frequency Switching and Synchronous Rectification



Halogen-Free

Pin Description



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
Common Ratings ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)			
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_{Jmax}	Maximum Junction Temperature	175	$^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 175	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ 298	A
Mounted on Large Heat Sink			
$I_{DP}^{①}$	Pulse Drain Current	$T_C=25^\circ\text{C}$ 1192	A
$I_D^{②}$	Continuous Drain Current($V_{GS}=10V$)	$T_C=25^\circ\text{C}$ 298	A
		$T_C=100^\circ\text{C}$ 210	
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 172	W
		$T_C=100^\circ\text{C}$ 86	
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.87	$^\circ\text{C/W}$
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	40	$^\circ\text{C/W}$
Drain-Source Avalanche Ratings			
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed	841	mJ

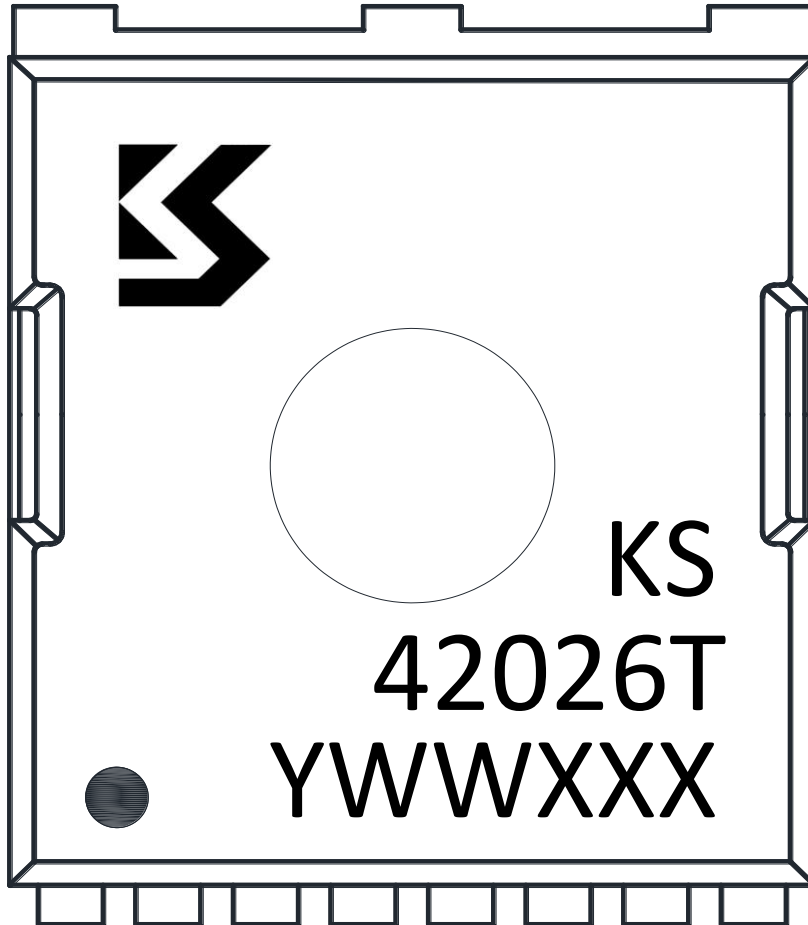
Electrical Characteristics ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	KS42026LBT			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V$			1	μA
		$T_J=125^\circ\text{C}$			30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1.1	1.5	2.3	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$R_{DS(ON)}^{(5)}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=20A$		0.9	1.1	$m\Omega$
		$V_{GS}=4.5V, I_{DS}=15A$		1.1	1.4	$m\Omega$
Diode Characteristics						
$V_{SD}^{(5)}$	Diode Forward Voltage	$I_{SD}=20A, V_{GS}=0V$		0.74	1.2	V
t_{rr}	Reverse Recovery Time	$I_{SD}=20A, di_{SD}/dt=100A/\mu s$		47		ns
Q_{rr}	Reverse Recovery Charge			34		nC
Dynamic Characteristics⁽⁶⁾						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$		2.3		Ω
C_{iss}	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=200KHz		5980		pF
C_{oss}	Output Capacitance			2050		
C_{rss}	Reverse Transfer Capacitance			125		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=20V, I_{DS}=20A,$ $V_{GEN}=10V, R_G=3\Omega$		20		ns
t_r	Turn-on Rise Time			55		
$t_{d(OFF)}$	Turn-off Delay Time			97		
t_f	Turn-off Fall Time			64		
Gate Charge Characteristics⁽⁶⁾						
Q_g	Total Gate Charge	$V_{DS}=20V, V_{GS}=10V,$ $I_{DS}=20A$		104		nC
Q_{gs}	Gate-Source Charge			14		
Q_{gd}	Gate-Drain Charge			17		

- Notes:
- ① Pulse width limited by safe operating area.
 - ② Calculated continuous current based on maximum allowable junction temperature.
 - ③ When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.
 - ④ Limited by T_{Jmax} , Starting $T_J = 25^\circ\text{C}$, $I_{ASmax} = 58A$, $L = 0.5\text{mH}$, $V_{DD} = 32V$, $R_G = 25\Omega$, $V_{GS} = 10V$. Part not recommended for use above this value. 100% Final Test at $I_{AS} = 40A$, $L = 0.5\text{mH}$.
 - ⑤ Pulse test; Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
 - ⑥ Guaranteed by design, not subject to production testing.

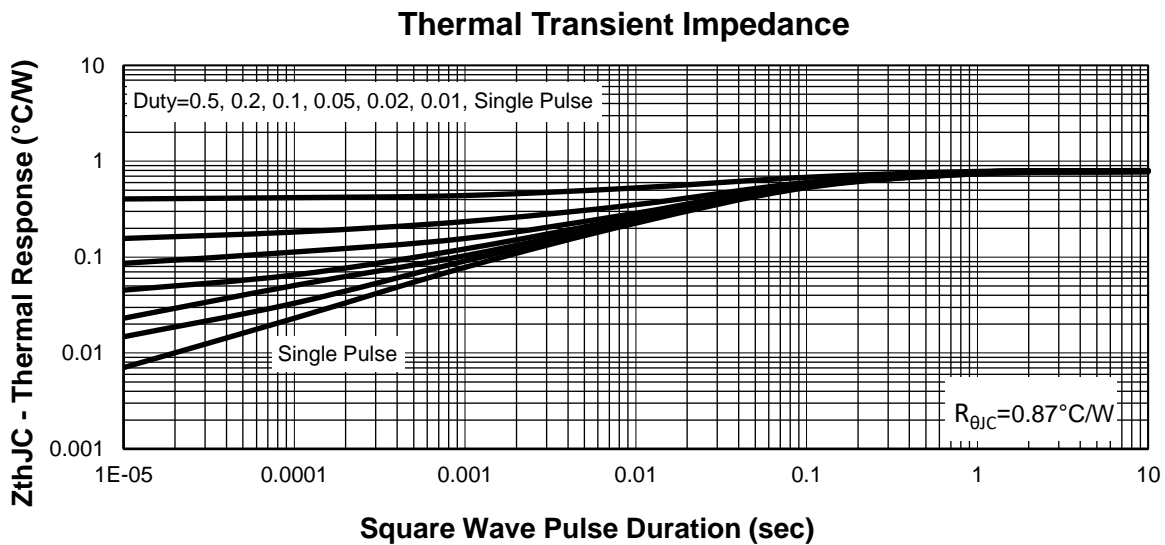
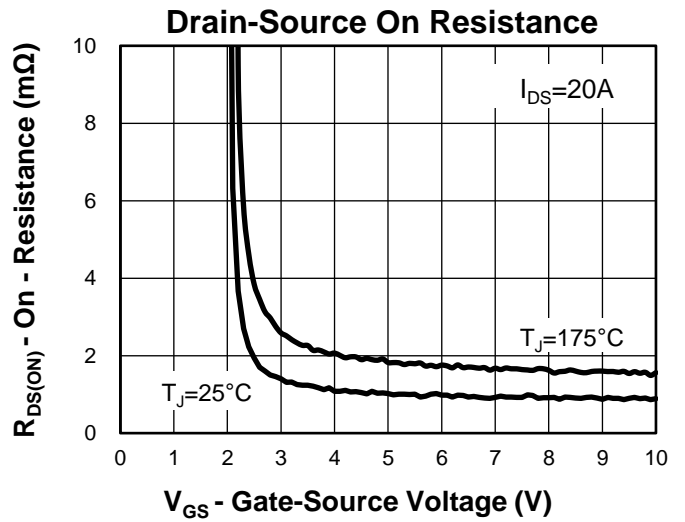
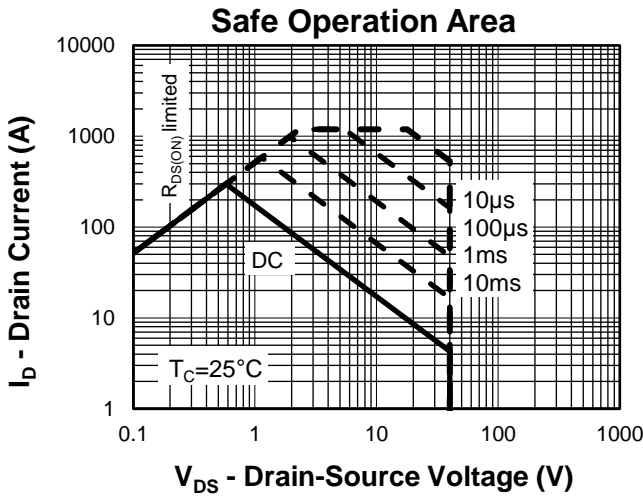
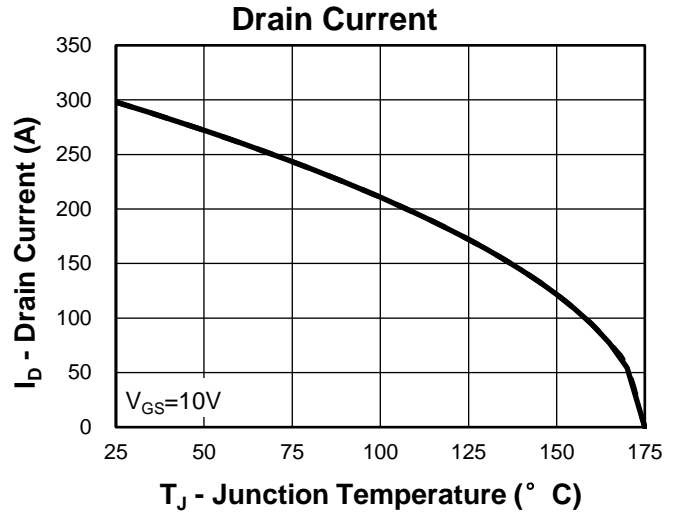
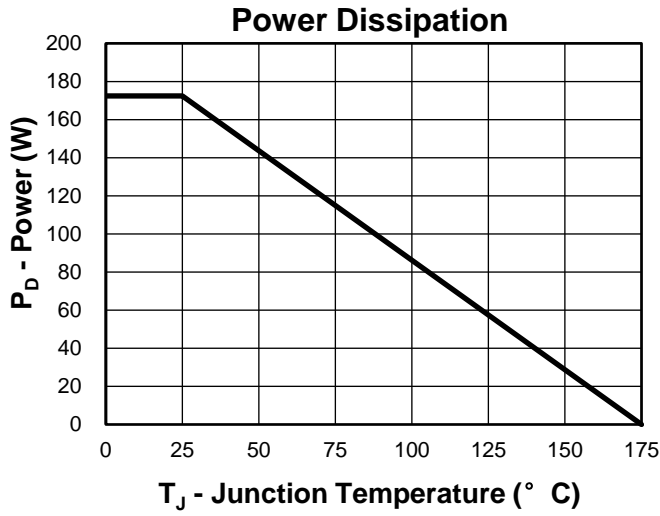
Ordering and Marking Information

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS42026LBT	TOLL	Tape&Reel	2000	13"	24mm

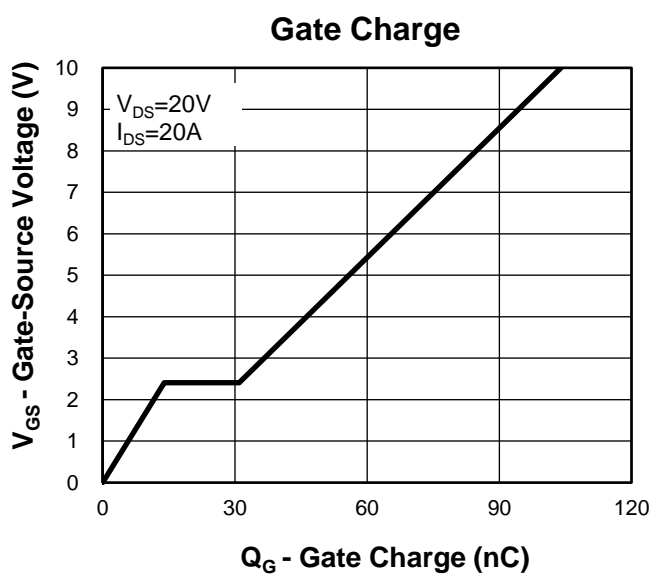
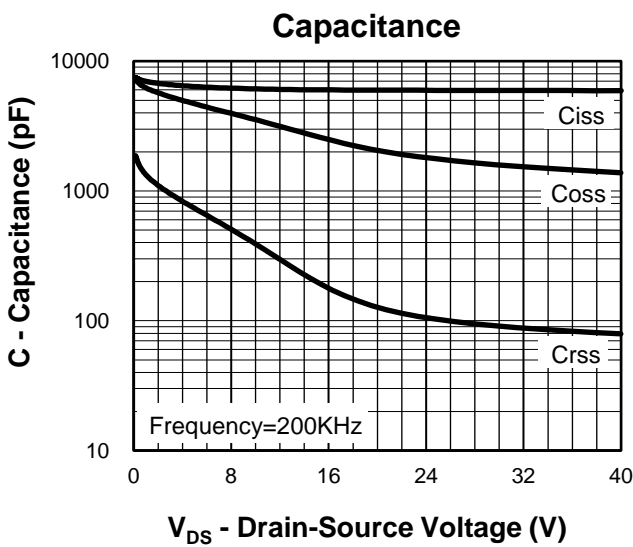
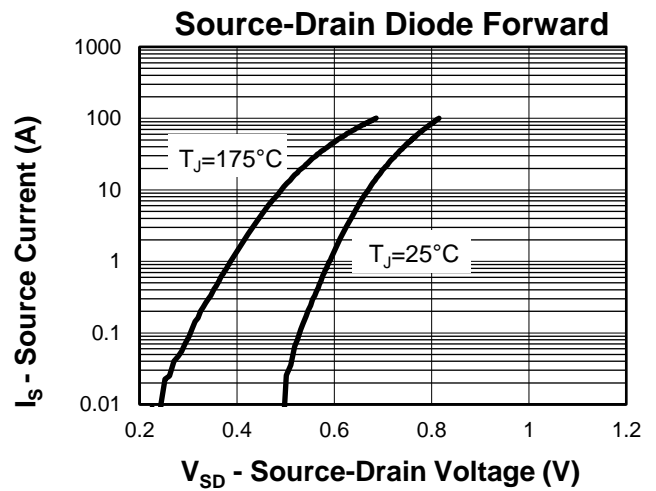
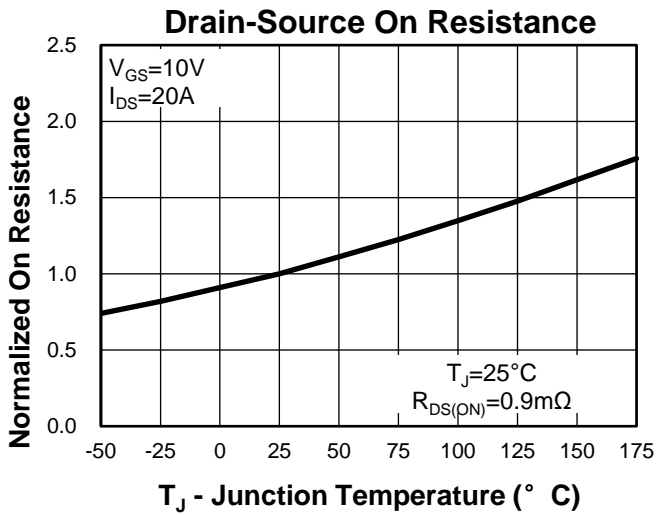
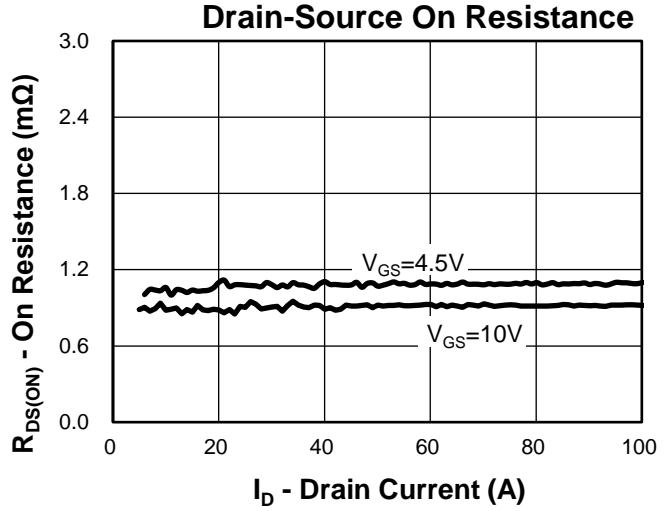
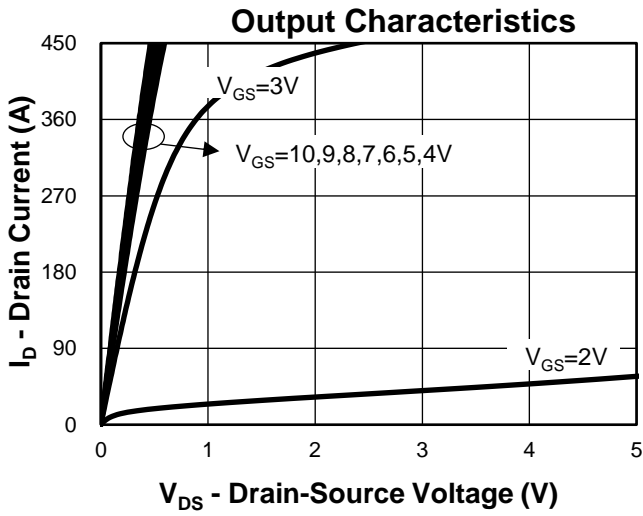


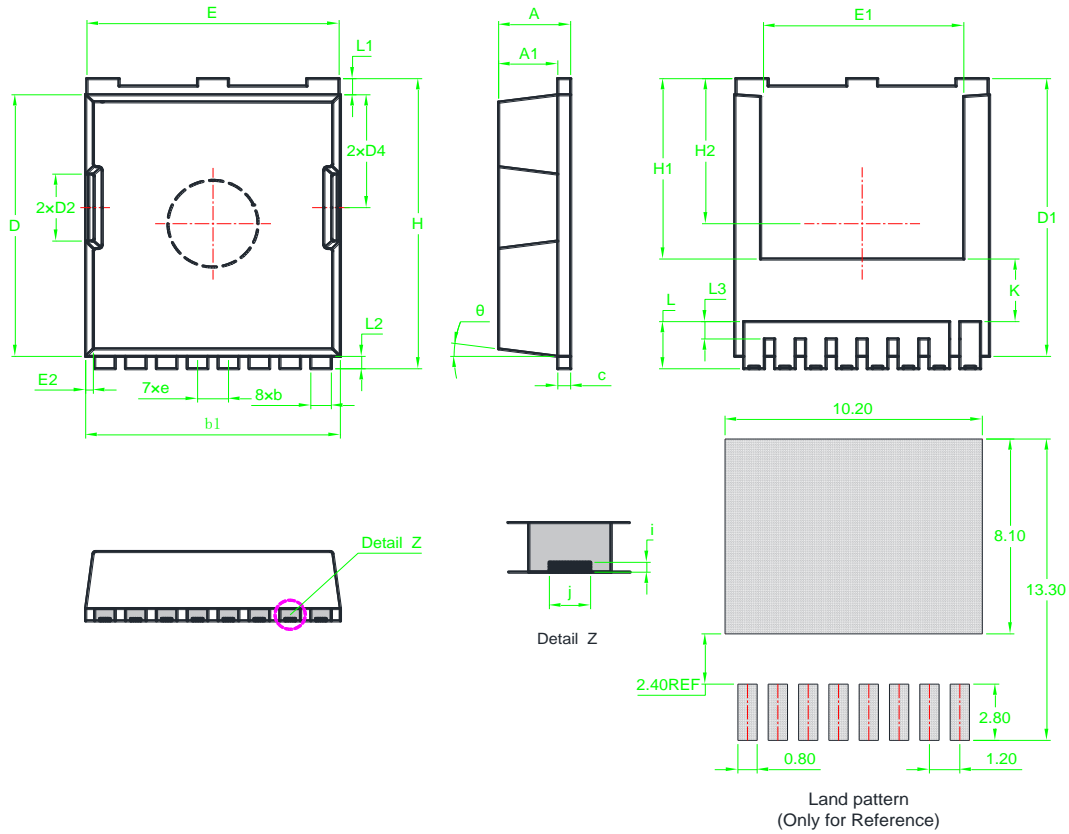
1st Line: Kwansemi LOGO
2nd Line: Kwansemi Code(KS)
3rd Line: Part Number(42026T)
4th Line: Lot Number(YWWXXX)

Typical Characteristics



Typical Characteristics

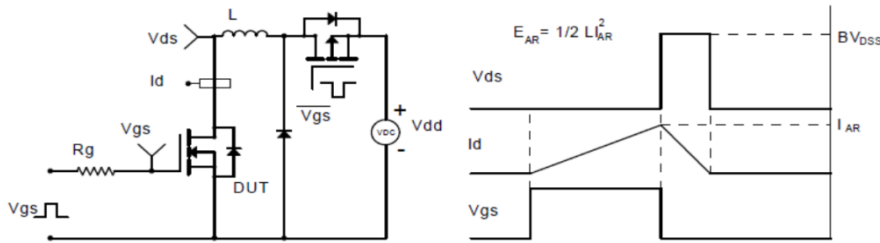


Package Information
TOLL


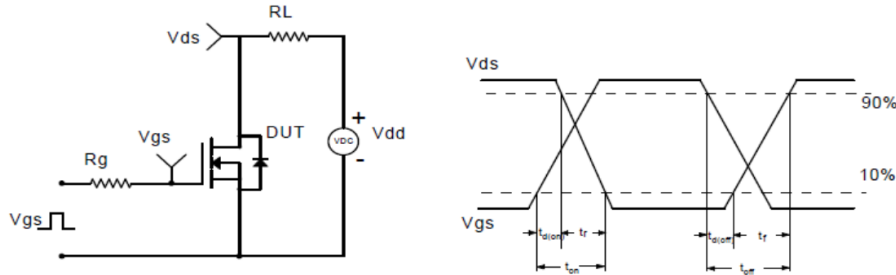
SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	2.20	2.30	2.40	0.087	0.091	0.094	e	1.20BSC			0.047REF		
A1	1.70	1.80	1.90	0.067	0.071	0.075	H	11.58	11.68	11.78	0.455906	0.459843	0.46378
b	0.65	*	0.90	0.026	*	0.035	H1	6.95BSC			0.274BSC		
b1	9.80	9.90	10.00	0.386	0.390	0.394	H2	5.90BSC			0.232BSC		
c	0.40	0.50	0.60	0.016	0.020	0.024	i	0.10REF			0.004REF		
D	10.28	10.38	10.48	0.405	0.409	0.413	j	0.40REF			0.016REF		
D1	10.98	11.08	11.28	0.432	0.436	0.444	K	3.0REF			0.118REF		
D2	3.20	3.30	3.40	0.126	0.130	0.134	L	1.60	*	2.10	0.063	*	0.083
D4	4.45	4.55	4.65	0.175	0.179	0.183	L1	0.60	0.70	0.80	0.024	0.028	0.031
E	9.80	9.90	10.00	0.386	0.390	0.394	L2	0.50	0.60	0.70	0.020	0.024	0.028
E1	8.00	8.10	8.20	0.315	0.319	0.323	L3	0.40	*	0.80	0.016	*	0.031
E2	0.30	*	0.80	0.012	*	0.031	θ	10° REF			10° REF		

Note: Dimensions do not inclusive burrs and mold flash.

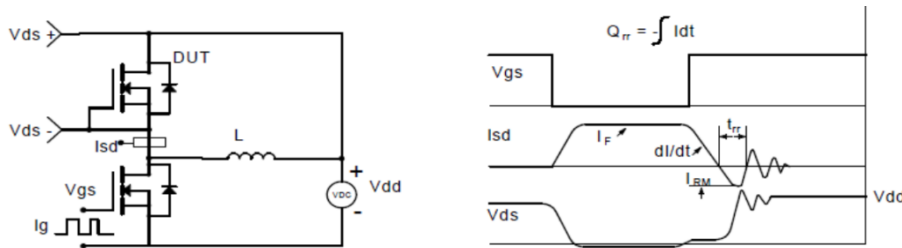
Avalanche Test Circuit and Waveforms



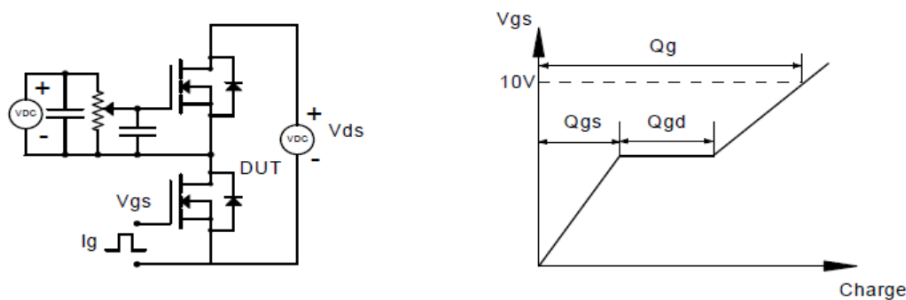
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

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